

TLC59210

SCLS711-MARCH 2009

8-BIT DMOS SINK DRIVER WITH LATCH

APPLICATIONS

Hammer

Relay

Lamp and Display (LED)

CLR [

D1 🗌 2

D2

D3 4

D4 🛛 5

D5 🗌 6

D6 7

D7 🗌

D8 9

CLK 10

1

3

8

N OR PW PACKAGE

(TOP VIEW)

20 V_{CC}

19 🗌 Y1

18 Y2

17 Y3

 $16 \overline{1}\overline{Y4}$

15 **Y**5

14 Y6

13 Y7

12 Y8

11 GND

FEATURES

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- DMOS Process
- High Voltage Output (V_{ds} = 30 V)
- Output Current on Each Channel (I_{ds} Max = 200 mA)
- Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17
- ESD Protection Exceeds JESD 22
 - 2000-V Human Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged Device Model (C101)
- LED Driver Application
- Output Clamp Diodes (Parasitic)
- Control Pins of CLR and CLK Inputs
- Clock Input up to 1 MHz

DESCRIPTION

The TLC59210 is an 8-bit flip-flop driver for LED and solenoid with Schmitt-trigger buffers designed for 5-V V_{CC} operation.

These circuits are positive-edge-triggered D-type flip-flops with a direct clear ($\overline{\text{CLR}}$) input. Information at the data (D) input meeting the setup time requirements is transferred to the $\overline{\text{Y}}$ output on the positive-going edge of the clock (CLK) pulse. Clock triggering occcurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When CLK is at either the high or low level, the D input has no effect at the output.

The TLC59210 is characterized for operation from -40°C to 85°C.

ORDERING INFORMATION⁽¹⁾

T _A	PACK	AGE ⁽²⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	PDIP – N	Reel of 1000	TLC59210IN	Y59210
-40 0 10 85 0	TSSOP – PW	Reel of 2000	TLC59210IPWR	Y59210

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



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FUNCTION TABLE (EACH LATCH)⁽¹⁾

	INPUTS	OUTPUT	
CLR	CLK	D	Y
L	Х	Х	H*
Н	↑	L	H*
Н	↑	н	L
Н	L	Х	Y ₀
Н	Ļ	Х	Y ₀

(1) L: Low-level

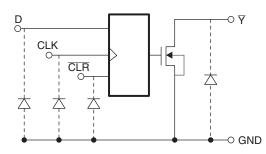
H: High-level

H*: with pullup resistor X: Irrelevant

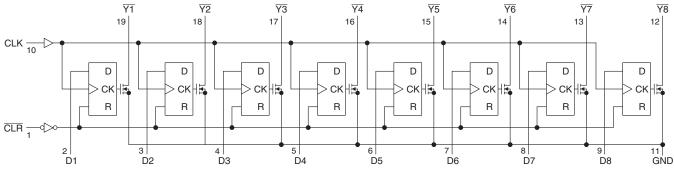
↑: Rising edge

↓: Falling edge Z : High-impedance (OFF)

OUTPUT SCHEMATIC



LOGIC SYMBOL⁽¹⁾



Fro uct old r Link(s · TLC55 210

(1) This symbol is in accordance with ANSI/IEEE Standard 91-1984 and IEC Publication 617-12.

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ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

				MIN	MAX	UNIT	
V _{CC}	Supply voltage range			-0.5	7	V	
D	Input voltage range			-0.5	7	V	
V _{ds}	Output voltage range	H output		-0.5	32	V	
1		1 bit for output low	$V_{CC} = 3 V \text{ to } 3.6 V$		100		
Ids	Output current range	1 bit for output low,	V_{CC} = 4.5 V to 5.5 V		200	mA	
I _{IK}	Input clamp current	V _I < 0 V			-20	mA	
0	Deckare thermal impedance ⁽²⁾	N package			69	°C/W	
θ_{JA}	Package thermal impedance ⁽²⁾	PW package			83	°C/vv	
	Operating free-air temperature range			-40	85	°C	
T _{stg}	Storage temperature range			-65	150	°C	

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The package thermal impedance is calculated in accordance with JESD 51-7.

RECOMMENDED OPERATING CONDITIONS

		CON	MIN	MAX	UNIT		
V _{CC}	Supply voltage			3	5.5	V	
VIH	High-level input voltage			V _{CC} × 0.7	V _{CC}	V	
VIL	Low-level input voltage			0	$V_{CC} \times 0.3$	V	
V_{ds}	Output voltage				30	V	
		N package,	Duty cycle < 42%		200		
	Output ourreat	$V_{CC} = 4.5$ V to 5.5 V	Duty cycle < 100%		130		
ds	Output current	PW package,	Duty cycle < 24%		200	mA	
		$V_{CC} = 4.5 \text{ V}$ to 5.5 V	Duty cycle < 100%		95		
T _A	Operating free-air temperature				85	°C	

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SCLS711-MARCH 2009 ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CC} = 4.5$ V to 5.5 V, $T_A = -40$ °C to 85°C (unless otherwise noted)

	PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT	
V_{T+}	Positive-going input threshold	D, CLR, CLK			3.5	V	
V_{T-}	Negative-going input threshold	D, CLR, CLK		1.5			V
V_{HYS}	Hysteresis	D, CLR, CLK		0.5		2	V
I _{IH}	High-level input current	$V_{CC} = 5.5 \text{ V}, \text{ V}_{I} = 5.5 \text{ V}$		0	1	μA	
IIL	Low-level input current	$V_{CC} = 5.5 \text{ V}, \text{ V}_{I} = 0 \text{ V}$		0	-1	μΑ	
I _{OZ}	Leakage current	V _{ds} = 30 V			5	μΑ	
I _{off}	Leakage current	$V_{I} = 0$ to 5 V, $V_{O} = 0$ to 30 V, $V_{CC} = 0$		0	5	μA	
	Querra la companya		Output = all OFF		0	5	•
I _{CC}	Supply current	$V_{I} = 0$ to 5 V, $V_{O} = 0$ to 30 V, $V_{CC} = 0$	Output = all ON		0	5	μA
		V _{CC} = 4.5 V, I _O = 100 mA		0.2	0.35	V	
V _{OL} Low-level output voltage		V _{CC} = 4.5 V, I _O = 200 mA		0.5	0.7	V	
r _{ON}	ON-state resistance	V _{CC} = 4.5 V, I _O = 100 mA		2	3.5	Ω	
Ci	Input capacitance	$V_{I} = V_{CC}$ or GND			5		pF

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V_{CC} = 4.5 V to 5.5 V, T_A = -40°C to 85°C (unless otherwise noted), see Figure 1

PARAMETER	TEST	LOAD	т	_A = 25°C		$T_A = -40^{\circ}C$ to 8	85°C	
PARAMETER	CONDITIONS	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	UNIT
t _{TLH}	Output = low to high	$\begin{array}{c} C_L = 30 \text{ pF}, \text{ R}_L = 240 \Omega, \\ 24\text{-V pullup} \end{array}$		180	230		260	ns
t _{THL}	Output = high to low	$\begin{array}{c} C_L = 30 \text{ pF}, \text{ R}_L = 240 \ \Omega, \\ 24\text{-V pullup} \end{array}$		300	450		500	ns
t _{PLH}	Output = low to high	$\begin{array}{c} C_L = 30 \text{ pF}, \text{ R}_L = 240 \ \Omega, \\ 24\text{-V pullup} \end{array}$		320	480		550	ns
t _{PHL}	Output = high to low	$\begin{array}{c} C_L = 30 \text{ pF}, \text{ R}_L = 240 \ \Omega, \\ 24\text{-V pullup} \end{array}$		320	480		550	ns
t _{PHLR}	CLR-Y	$\begin{array}{c} C_L = 30 \text{ pF}, \text{ R}_L = 240 \ \Omega, \\ 24\text{-V pullup} \end{array}$		320	480		550	ns

TIMING REQUIREMENTS

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over recommended operating free-air temperature range, V_{CC} = 4.5 V to 5.5 V, O/C to Y (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	T _A = -40°C to 3	UNIT	
	FARAMEI	EK	TEST CONDITIONS	MIN	MAX	UNIT
t _{su}	Setup time	CLK↑	$V_{DD} = 4.5 V$	10		ns
t _h	Hold time	CLK↑	$V_{DD} = 4.5 V$	10		ns
tw	Pulse width	CLK, CLR	V _{DD} = 4.5 V	30		ns



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ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CC} = 3 V$ to 3.6 V, $T_A = -40^{\circ}C$ to 85°C (unless otherwise noted)

				-			
	PARAMETER	TEST CONDITION	TEST CONDITIONS				UNIT
V_{T+}	Positive-going input threshold	D, CLR, CLK	D, <u>CLR</u> , CLK				V
V_{T-}	Negative-going input threshold	D, CLR, CLK		0.9			V
V_{HYS}	Hysteresis	D, CLR, CLK		0.33		1.32	V
IIH	High-level input current	$V_{CC} = 3.6 \text{ V}, \text{ V}_{I} = 3.6 \text{ V}$			0	1	μA
IIL	Low-level input current	$V_{CC} = 3.6 \text{ V}, \text{ V}_{I} = 0 \text{ V}$		0	-1	μA	
I _{OZ}	Leakage current	V _O = 30 V			5	μA	
I _{off}	Leakage current	$V_{CC} = 0 V, V_{I} = 0 \text{ to } 3.6 V, V_{O} = 0 \text{ to } 3.6 V_{$	30 V		0	5	μA
	Supply ourrent	$V_{CC} = 3.6 \text{ V}, \text{ V}_{I} = 0 \text{ to } 3.6 \text{ V}, \text{ V}_{O} = 0$	Output = all OFF		0	5	
I _{CC}	Supply current	to 30 V	Output = all ON		0	5	μA
V _{OL}	Low-level output voltage	V _{CC} = 3 V, I _O = 100 mA		0.35	0.7	V	
r _{ON}	ON-state resistance	$V_{CC} = 4.5 \text{ V}, \text{ I}_{O} = 100 \text{ mA}$		3.5	7	Ω	
Ci	Input capacitance	$V_{I} = V_{CC}$ or GND			5		pF

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CC} = 3 \text{ V}$ to 3.6 V, $T_A = -40^{\circ}\text{C}$ to 85°C (unless otherwise noted), see Figure 1

PARAMETER	TEST	LOAD	т	_A = 25°C		T _A = -40°C to 85°C	UNIT
FARAMETER	CONDITIONS	CAPACITANCE	MIN	TYP	MAX	MIN MAX	UNIT
t _{TLH}	Output = low to high	$C_L = 30 \text{ pF}, R_L = 240 \Omega,$ 24-V pullup		300	450	500	ns
t _{THL}	Output = high to low	$C_L = 30 \text{ pF}, R_L = 240 \Omega,$ 24-V pullup		300	450	500	ns
t _{PLH}	Output = low to high	$C_L = 30 \text{ pF}, R_L = 240 \Omega,$ 24-V pullup		500	700	850	ns
t _{PHL}	Output = high to low	$\begin{array}{c} C_{L}=30 \text{ pF}, R_{L}=240 \Omega,\\ 24\text{-V pullup} \end{array}$		500	700	850	ns
t _{PHLR}	CLR-Y	$C_L = 30 \text{ pF}, R_L = 240 \Omega,$ 24-V pullup		500	700	850	ns

TIMING REQUIREMENTS

over recommended operating free-air temperature range, V_{CC} = 3 V to 3.6 V, O/C to Y (unless otherwise noted)

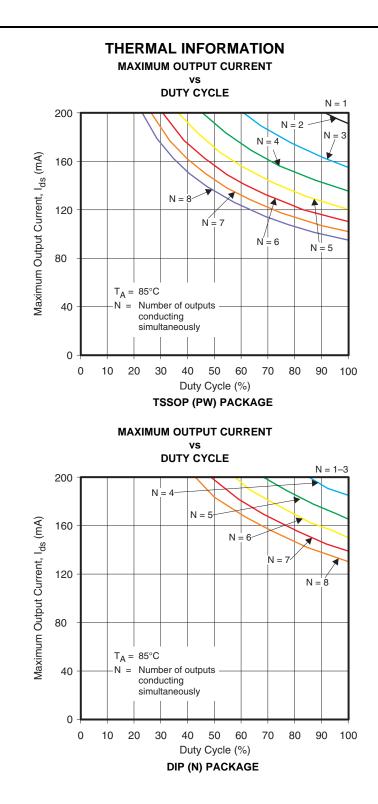
	PARAMETER		TEST CONDITIONS	T _A = -40°C to 8	UNIT	
	FARAMEI	EK	TEST CONDITIONS	MIN	MAX	UNIT
t _{su}	Setup time	CLK↑	$V_{DD} = 3 V$	10		ns
t _h	Hold time	CLK↑	$V_{DD} = 3 V$	10		ns
tw	Pulse width	CLK, CLR	V _{DD} = 3 V	30		ns

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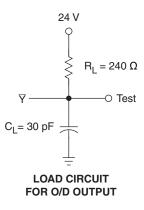


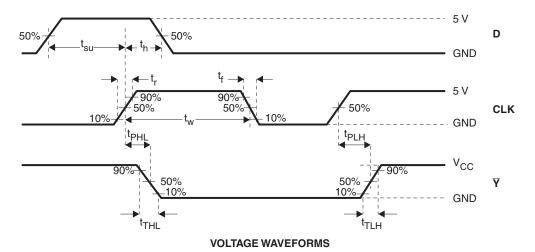
TLC59210

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PARAMETER MEASUREMENT INFORMATION





- A. C_L includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_r \leq 3 ns, and t_f \leq 3 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Test Circuit and Voltage Waveforms

Product fold r Lirk(s · TLC59 210

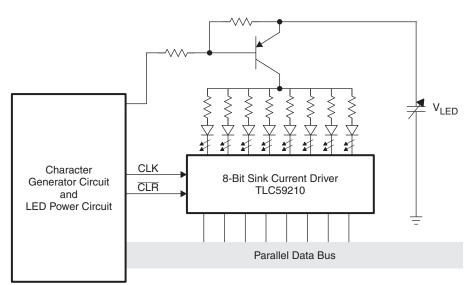
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TEXAS INSTRUMENTS

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APPLICATION INFORMATION



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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLC59210IN	ACTIVE	PDIP	Ν	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TLC59210IPWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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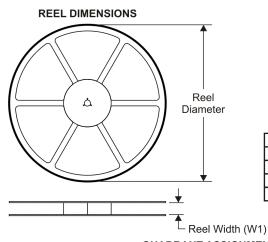
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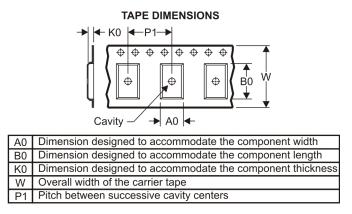
PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	

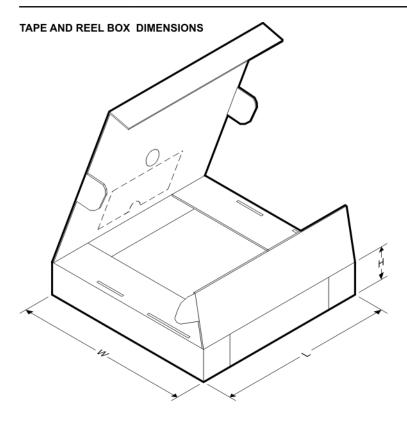
Devi	ce	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLC5921	0IPWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1

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PACKAGE MATERIALS INFORMATION

20-Jun-2009



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLC59210IPWR	TSSOP	PW	20	2000	346.0	346.0	33.0

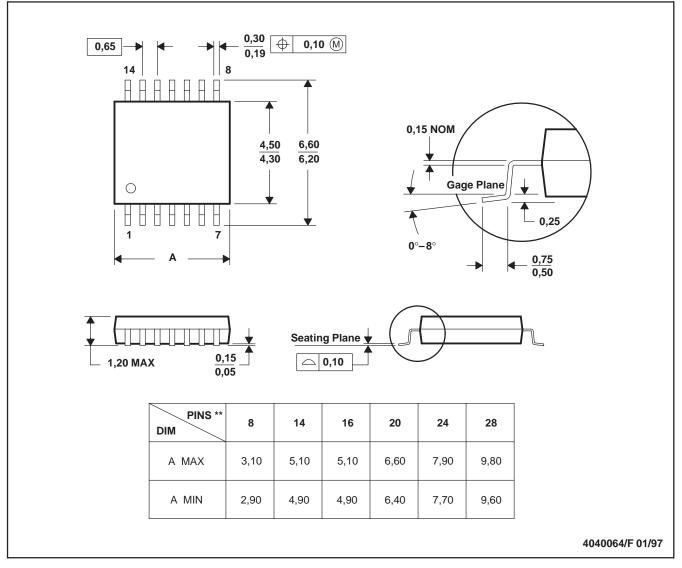
MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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